

DATA SHEET

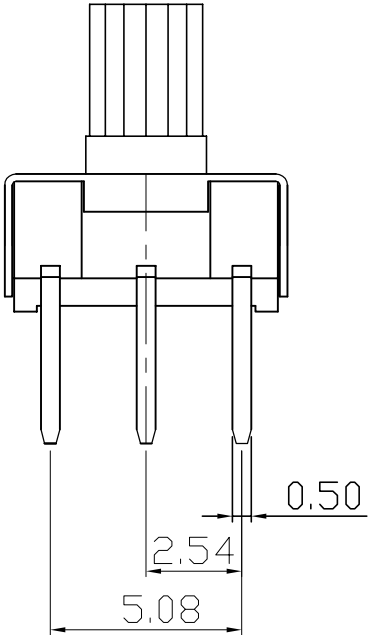
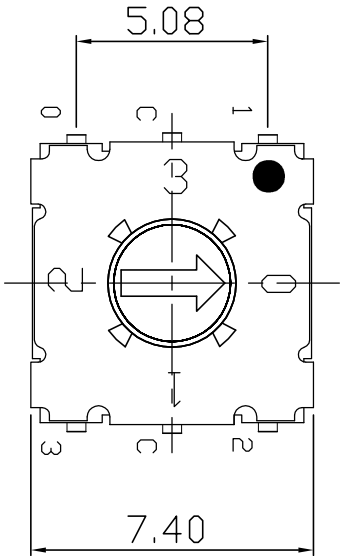
SUNGMUN CODE : MSSM-04

DESCRIPTION : MINI ROTARY DIP SWITCH

SUNGMUN ELECTRONICS CO., LTD.

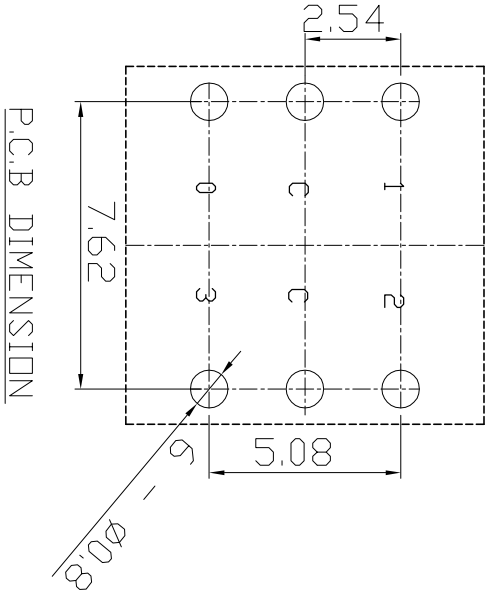
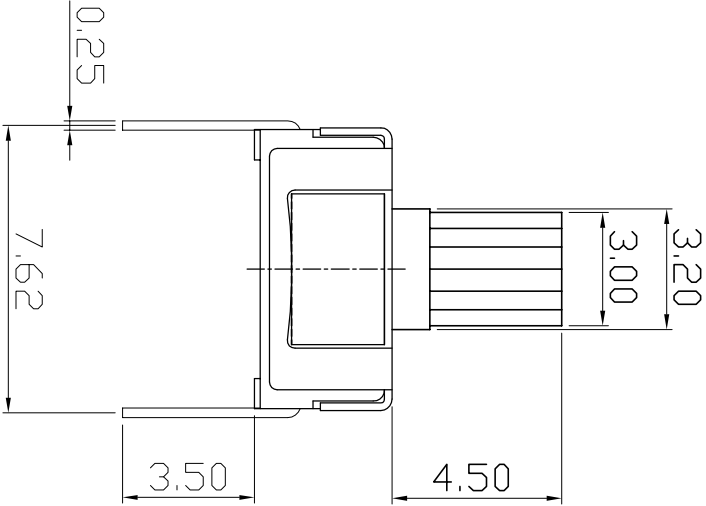
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WRK	DATE	REMARKS
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- SPECIFICATION**
- Operating Voltage : 50V (None-Switching : 100mA) (Switching : 100mA)
 - Contact Resistance : 100mΩ Max
 - Insulation Resistance : 100MΩ Min
 - Operating Force : 200gf·cm Max
 - Life Cycle : 10,000 steps
 - Sealing : Comparable IP67

P o s i t i o n	Coded				
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0	●	●			
1	●		●		
2	●			●	
3	●				●



APPD	CHKD	D'SGD	TITLE: MINI ROTARY DIP SWITCH		
K.L LEE	J.P ROH	W.J LEE	MODEL NO.	MSSM-04	
			REV	A	
SUNG MUN ELECTRONICS CO., LTD.					

1. Style:

This specification describes "7.4X7.4 size of Mini Rotary Dip Switch" which is M series.

1.1 Operating / Storage Temperature Range : -60°C ~ +125°C

2. Rating:

2.1 None-Switching : 400 mA, DC 42V

2.2 Switching : 100 mA, DC 42V

3. Type of Actuation : Rotating

4. Electrical Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
4-1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.
4-2	Contact Resistance	① To be measured between the two terminals associated with each switch pole. ② Measurements shall be made with a 1kHz shall current contact resistance meter.	80mΩ max. (initial)
4-3	Insulation Resistance	250V DC	100 MΩ min.
4-4	Dielectric withstanding Voltage	250V AC(50Hz or 60Hz)shall be applied between all the adjacent terminal and between the terminal and the frame for 1 minute.	There shall be no breakdown or flashover.

5. Mechanical Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
5-1	Operation Force	Operating direction shall be clockwise or counter clockwise direction	120gf•cm $\pm$ 30 max
5-2	Operation Life	Measurements shall be made following the test set forth below: 1)100mA, 42V DC resistive load 2)Rate of operation: 15~20 cycles/ minute 3)Step of operation: 25,000 steps	1)As shown in item 4-3,4-4 2)Contact Resistance: 200m Ω max 3)Final-after test

6. Environmental Characteristics

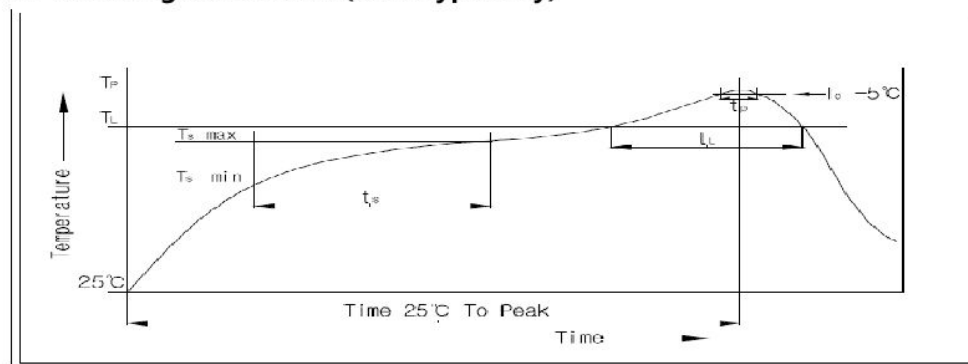
ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
6-1	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: -60°C $\pm$ 3°C 2)Time: 96 hours	1)As shown in item 4-3, 4-4, 5-1 2)Contact Resistance: 200m Ω max
6-2	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 125°C $\pm$ 2°C 2)Time: 96 hours	1)As shown in item 4-3, 4-4, 5-1 2)Contact Resistance: 200m Ω max
6-3	Resistance Humidity	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 40°C $\pm$ 2°C 2)Relative humidity: 90~95% 3)Time: 96 hours	1)As shown in item 4-4, 5-1 2)Contact Resistance: 200m Ω max 3)Insulation Resistance: 10 M Ω min

7. This item is "RoHS" Compliant

8. Manual Soldering : Max 350°C, 3 sec.

9. Wave Soldering : Max 280°C, 5 sec.

10. Reflow Soldering Conditions: (SMD type only)



10-1 Condition for Soldering

Profile Feature	Pb-Free Assembly
Average Ramp-UP Rate(T_S max to T_P)	3°C/second max
Preheat	
- Temperature Min(T_S min)	150°C
- Temperature Max(T_S max)	200°C
- Time (t_S min to t_S max)	60-180seconds
Time maintained above:	
- Temperature (T_L)	217°C
- Time (t_L)	60-150seconds
Peak/Classification Temperature(T_P)	260°C $+0^\circ\text{C}/-5^\circ\text{C}$
Time within 5°C of actual Peak Temperature(T_P)	Min 30 seconds
Ramp-Down Rate	6°C/sec max
Time 25°C to Peak Temperature	8 minutes max